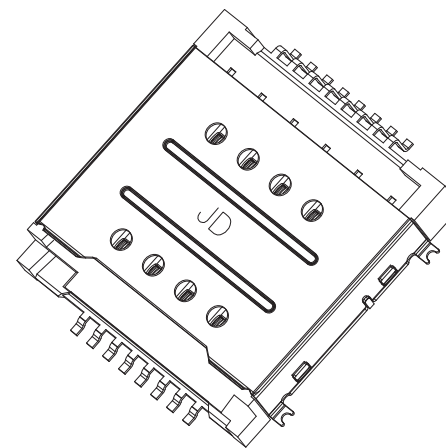
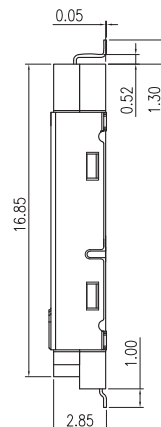
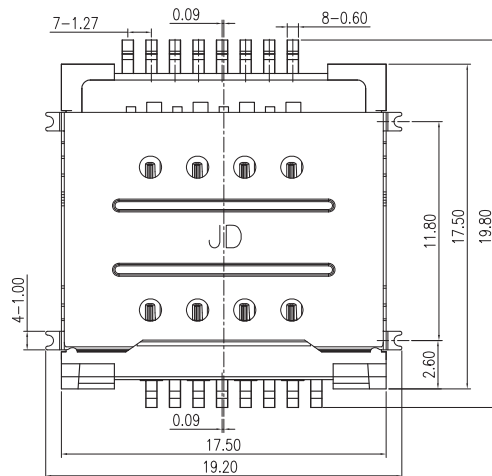
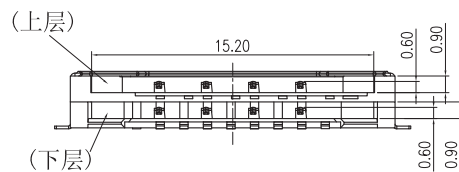
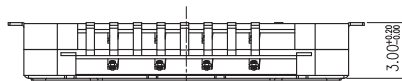


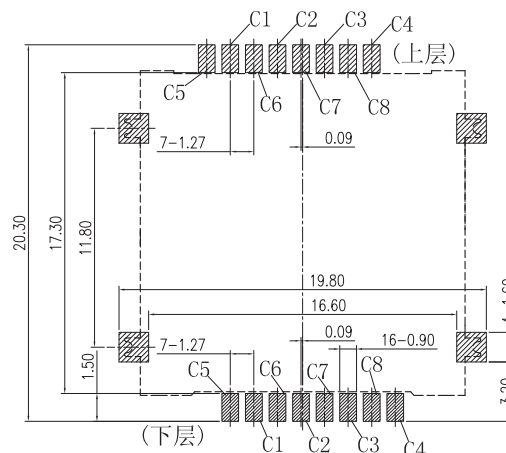
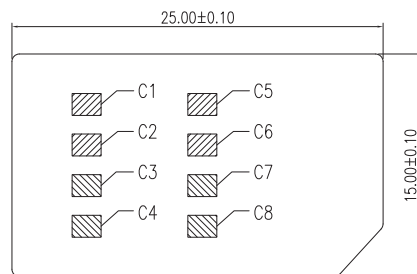
双层 SIM CARD CONNECTOR (短上层)



MicroSIM CARD	
Pin No.	NAME
C1	VCC(供电电压)
C2	RST(时钟)
C3	CLK(重置)
C4	Reserved
C5	GND(接地)
C6	VPP(程序电压)
C7	I/O(输入输出)
C8	Reserved

NOTES:

- MATERIAL
HOUSING:THERMOPLASTIC,UL94V-0;COLOR:BLACK
CONTACT:COPPER ALLOY
SHELL:STAINLESS STEEL
- FINISH
CONTACT: NICKEL UNDERPLATED AND GOLD PLANTING OVER ALL.
OR NICKEL UNDERPLATED AND GOLD PLANTING ON CONTACT AREA;Tim PLANTING ON SOLDER AREA
SHELL: NICKEL UNDERPLATED AND GOLD PLANTING ON SOLDER AREA.



Recommended P.C.B. Layout(Tolerance=±0.05)
AS VIEW FORM COMPONENT SIDE

MANUFACTURE DWG		东莞市讯普电子科技有限公司 DongGuan XunPu Electronics Co.,Ltd		
UNLESS OTHERWISE SPECIFIED TOLERANCES		TITLE:双层SIM CARD		
DECIMALS:	ANGLES:	PAR	MCS-102JD	
X:±0.5	X:±2°	DWN	KING	2012.3.08
X.X:±0.3	X:±0.5	CHKD		
X.XX:±0.2		APVD		
		SCALE 1:1	UNIT: mm	
		CUSTOMER COPY	SIZE:A4	SHEET:1F1
				REV:A